

NCV8508 Series

Advance Information

Low Dropout Linear Regulators with Watchdog, RESET, and Wake Up

The NCV8508 is a precision micropower voltage regulator family. The part contains many of the required operational requirements for powering microprocessors. Its robustness makes it suitable for severe automotive environments. The devices low dropout voltage ensures operation of loads (i.e. microprocessors) when the battery voltage is low such as during the cranking cycle of an automobile. In addition to being a good fit for the automotive environment, the NCV8508 is ideal for use in battery operated, microprocessor controlled equipment because of its extremely low quiescent current.

Features

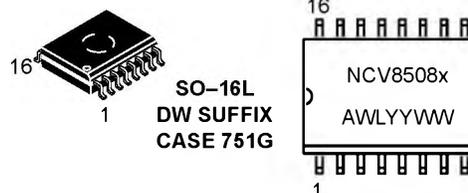
- Output Voltage Options: 3.3 V or 5.0 V
- $\pm 3.0\%$ Output Voltage
- I_{OUT} Up to 250 mA
- Quiescent Current Independent of Load
- Micropower Compatible Control Functions:
 - Wake Up
 - Watchdog
 - RESET
- Low Dropout Voltage
- Low Quiescent Current (100 μ A typ)
- Protection Features:
 - Thermal Shutdown
 - Short Circuit
 - 45 V Operation
- Internally Fused Leads in SO-16L Package



ON Semiconductor™

<http://onsemi.com>

MARKING DIAGRAMS



x = Voltage Ratings as Indicated Below:
3 = 3.3 V
5 = 5.0 V
A = Assembly Location
WL, L = Wafer Lot
YY, Y = Year
WW, W = Work Week

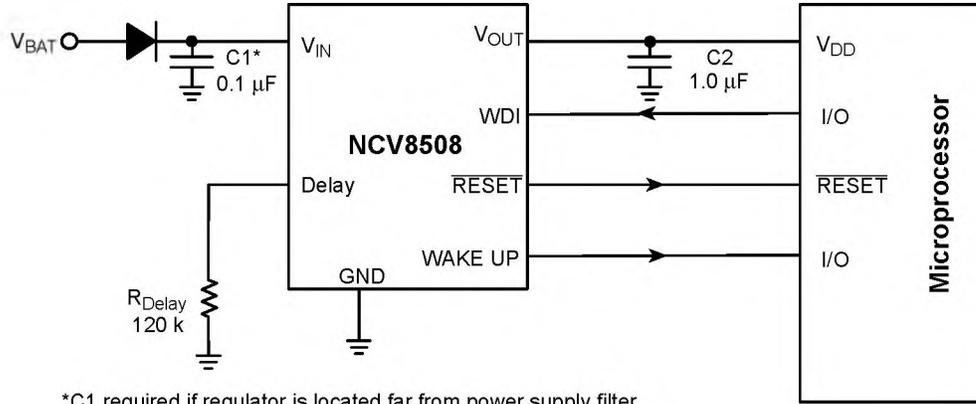
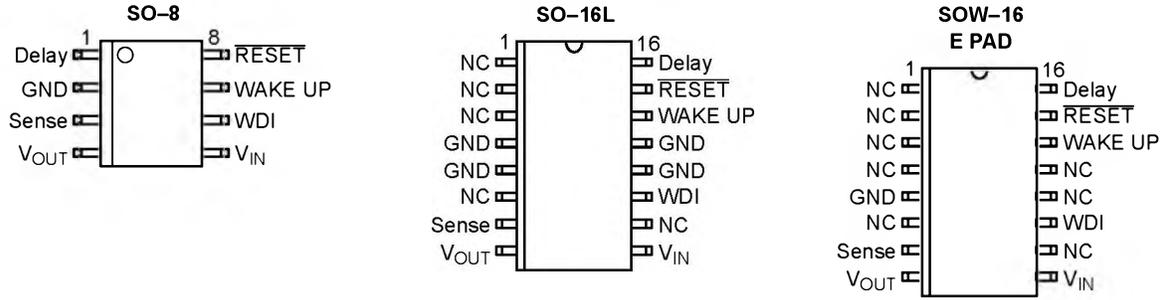
ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 954 of this data sheet.

This document contains information on a new product. Specifications and information herein are subject to change without notice.

NCV8508 Series

PIN CONNECTIONS



*C1 required if regulator is located far from power supply filter.

Figure 1. Application Circuit

MAXIMUM RATINGS*

| Rating | Value | Unit | |
|--|---|----------------------|----|
| Input Voltage, V _{IN} | -0.3 to 45 | V | |
| Output Voltage, V _{OUT} | -0.3 to 18 | V | |
| ESD Susceptibility (Human Body Model) | 2.0 | kV | |
| Logic Inputs/Outputs (Reset, WDI, Wakeup) | -0.3 to +7.0 | V | |
| Operating Junction Temperature, T _J | -40 to 150 | °C | |
| Storage Temperature Range, T _S | -55 to +150 | °C | |
| Package Thermal Resistance, SO-8: Junction-to-Case, R _{θJC} Junction-to-Ambient, R _{θJA} | 45 165 | °C/W °C/W | |
| Package Thermal Resistance, SO-16L: Junction-to-Case, R _{θJC} Junction-to-Ambient, R _{θJA} | 18 75 | °C/W °C/W | |
| Package Thermal Resistance, SOW-16 E PAD: Junction-to-Case, R _{θJC} Junction-to-Ambient, R _{θJA} | 1.0 36 | °C/W °C/W | |
| Lead Temperature Soldering: | Wave Solder (through hole styles only) (Note 1) Reflow: (SMD styles only) (Note 2) | 260 peak 230 peak | °C |

1. 10 second maximum.

2. 60 second maximum above 183°C.

*The maximum package power dissipation must be observed.

NCV8508 Series

ELECTRICAL CHARACTERISTICS ($-40^{\circ}\text{C} \leq T_J \leq 125^{\circ}\text{C}$; $6.0\text{ V} \leq V_{\text{IN}} \leq 28\text{ V}$, $100\ \mu\text{A} \leq I_{\text{OUT}} \leq 150\text{ mA}$, $C_2 = 1.0\ \mu\text{F}$, $R_{\text{Delay}} = 60\text{ k}$; unless otherwise specified.)

| Characteristic | Test Conditions | Min | Typ | Max | Unit |
|----------------|-----------------|-----|-----|-----|------|
|----------------|-----------------|-----|-----|-----|------|

Output

| | | | | | |
|--|---|-------|-------|-------|--------------------|
| Output Voltage, V_{OUT} for 3.3 V Option | – | 3.201 | 3.300 | 3.399 | V |
| Output Voltage, V_{OUT} for 5.0 V Option | – | 4.85 | 5.00 | 5.15 | V |
| Dropout Voltage ($V_{\text{IN}} - V_{\text{OUT}}$) | $I_{\text{OUT}} = 150\text{ mA}$. Note 3 | – | 425 | 800 | mV |
| Load Regulation | $V_{\text{IN}} = 14\text{ V}$, $100\ \mu\text{A} \leq I_{\text{OUT}} \leq 150\text{ mA}$ | – | 5.0 | 30 | mV |
| Line Regulation | $6.0\text{ V} \leq V_{\text{IN}} \leq 28\text{ V}$, $I_{\text{OUT}} = 5.0\text{ mA}$ | – | 5.0 | 20 | mV |
| Current Limit | – | 250 | 400 | – | mA |
| Thermal Shutdown | Guaranteed by Design | 150 | 180 | 210 | $^{\circ}\text{C}$ |
| Quiescent Current | $V_{\text{IN}} = 12\text{ V}$, $I_{\text{OUT}} = 150\text{ mA}$ | – | 100 | 150 | μA |

RESET

| | | | | | |
|----------------------------|--|------------------------|-------------------------|-------|----|
| Threshold for 3.3 V Option | – | 2.970 | 3.069 | 3.168 | V |
| Threshold for 5.0 V Option | – | 4.50 | 4.65 | 4.80 | V |
| Output Low | $R_{\text{LOAD}} = 10\text{ k}$ to V_{OUT} , $V_{\text{OUT}} \geq 1.0\text{ V}$ | – | 0.2 | 0.4 | V |
| Output High | $R_{\text{LOAD}} = 10\text{ k}$ to GND | $V_{\text{OUT}} - 0.5$ | $V_{\text{OUT}} - 0.25$ | – | V |
| Delay Time | $V_{\text{IN}} = 14\text{ V}$, $R_{\text{Delay}} = 60\text{ k}$, $I_{\text{OUT}} = 5.0\text{ mA}$ | 2.0 | 3.0 | 4.0 | ms |
| | $V_{\text{IN}} = 14\text{ V}$, $R_{\text{Delay}} = 120\text{ k}$, $I_{\text{OUT}} = 5.0\text{ mA}$ | – | 6.0 | – | ms |

Watchdog Input

| | | | | | |
|----------------|--|-----|-----|-----|--------------------|
| Threshold High | – | 70 | – | – | $\%V_{\text{OUT}}$ |
| Threshold Low | – | – | – | 30 | $\%V_{\text{OUT}}$ |
| Hysteresis | – | 25 | 100 | – | mV |
| Input Current | WDI = 6.0 V | – | 0.1 | +10 | μA |
| Pulse Width | 50% WDI falling edge to 50% WDI rising edge and 50% WDI rising edge to 50% WDI falling edge, (see Figure 5) | 5.0 | – | – | μs |

Wake Up Output ($V_{\text{IN}} = 14\text{ V}$, $I_{\text{OUT}} = 5.0\text{ mA}$)

| | | | | | |
|--|--|------------------------|-------------------------|-----|---------------|
| Wake Up Period | See Figures 4 and 5, $R_{\text{DELAY}} = 60\text{ k}$ | 19 | 25 | 31 | ms |
| | See Figures 4 and 5, $R_{\text{DELAY}} = 120\text{ k}$ | – | 50 | – | ms |
| Wake Up Duty Cycle Nominal | See Figure 3. | 45 | 50 | 55 | % |
| RESET HIGH to Wake Up Rising Delay Time | $R_{\text{DELAY}} = 60\text{ k}$ | 10 | 12.5 | 15 | ms |
| | 50% RESET rising edge to 50% Wake Up edge, $R_{\text{DELAY}} = 120\text{ k}$ (see Figures 3 and 4) | – | 25 | – | ms |
| Wake Up Response to Watchdog Input | 50% WDI falling edge to 50% Wake Up falling edge | – | 0.1 | 5.0 | μs |
| Wake Up Response to RESET | 50% RESET falling edge to 50% Wake Up falling edge. $V_{\text{OUT}} = 5.0\text{ V} \rightarrow 4.5\text{ V}$ | – | 0.1 | 5.0 | μs |
| Output Low | $R_{\text{LOAD}} = 10\text{ k}$ | – | 0.2 | 0.4 | V |
| Output High | $R_{\text{LOAD}} = 10\text{ k}$ | $V_{\text{OUT}} - 0.5$ | $V_{\text{OUT}} - 0.25$ | – | V |

3. Measured when the output voltage has dropped 100 mV from the nominal value

NCV8508 Series

ELECTRICAL CHARACTERISTICS (continued) ($-40^{\circ}\text{C} \leq T_J \leq 125^{\circ}\text{C}$; $6.0\text{ V} \leq V_{\text{IN}} \leq 28\text{ V}$, $100\ \mu\text{A} \leq I_{\text{OUT}} \leq 150\text{ mA}$, $C_2 = 1.0\ \mu\text{F}$, $R_{\text{Delay}} = 60\text{ k}$; unless otherwise specified.)

| Characteristic | Test Conditions | Min | Typ | Max | Unit |
|----------------|-----------------|-----|-----|-----|------|
|----------------|-----------------|-----|-----|-----|------|

Delay

| | | | | | |
|----------------|--|---|------|---|---|
| Output Voltage | I _{DELAY} = 50 μA . Note 4 | – | 1.25 | – | V |
|----------------|--|---|------|---|---|

4. Current drain on the Delay pin directly affects the Delay Time, Wake Up Period, and the $\overline{\text{RESET}}$ to Wake Up Delay Time..

PACKAGE PIN DESCRIPTION

| PACKAGE PIN # | | | PIN SYMBOL | FUNCTION |
|---------------|--------------|-----------------------|---------------------------|--|
| SO-8 | SO-16L | SOW-16 E PAD | | |
| 4 | 8 | 8 | V_{OUT} | Regulated output voltage $\pm 3.0\%$. |
| 5 | 9 | 9 | V_{IN} | Supply Voltage to the IC. |
| 6 | 11 | 11 | WDI | CMOS compatible input lead. The watchdog function monitors the falling edge of the incoming signal. |
| 2 | 4, 5, 12, 13 | 5 | GND | Ground connection. |
| 7 | 14 | 14 | WAKE UP | CMOS compatible output consisting of a continuously generated signal used to Wake Up the microprocessor from sleep mode. |
| 8 | 15 | 15 | $\overline{\text{RESET}}$ | CMOS compatible output lead $\overline{\text{RESET}}$ goes low whenever V_{OUT} drops by more than 7.0% from nominal, or during the absence of a correct watchdog signal. |
| 1 | 16 | 16 | Delay | Buffered bandgap voltage used to create timing current for $\overline{\text{RESET}}$ and Wake Up from R_{Delay} . |
| – | 1-3, 6, 10 | 1-4, 6, 10, 12, 13 | NC | No Connection. |
| 3 | 7 | 7 | Sense | Kelvin connection which allows remote sensing of the output voltage for improved regulation. Connect to V_{OUT} if remote sensing is not required. |

NCV8508 Series

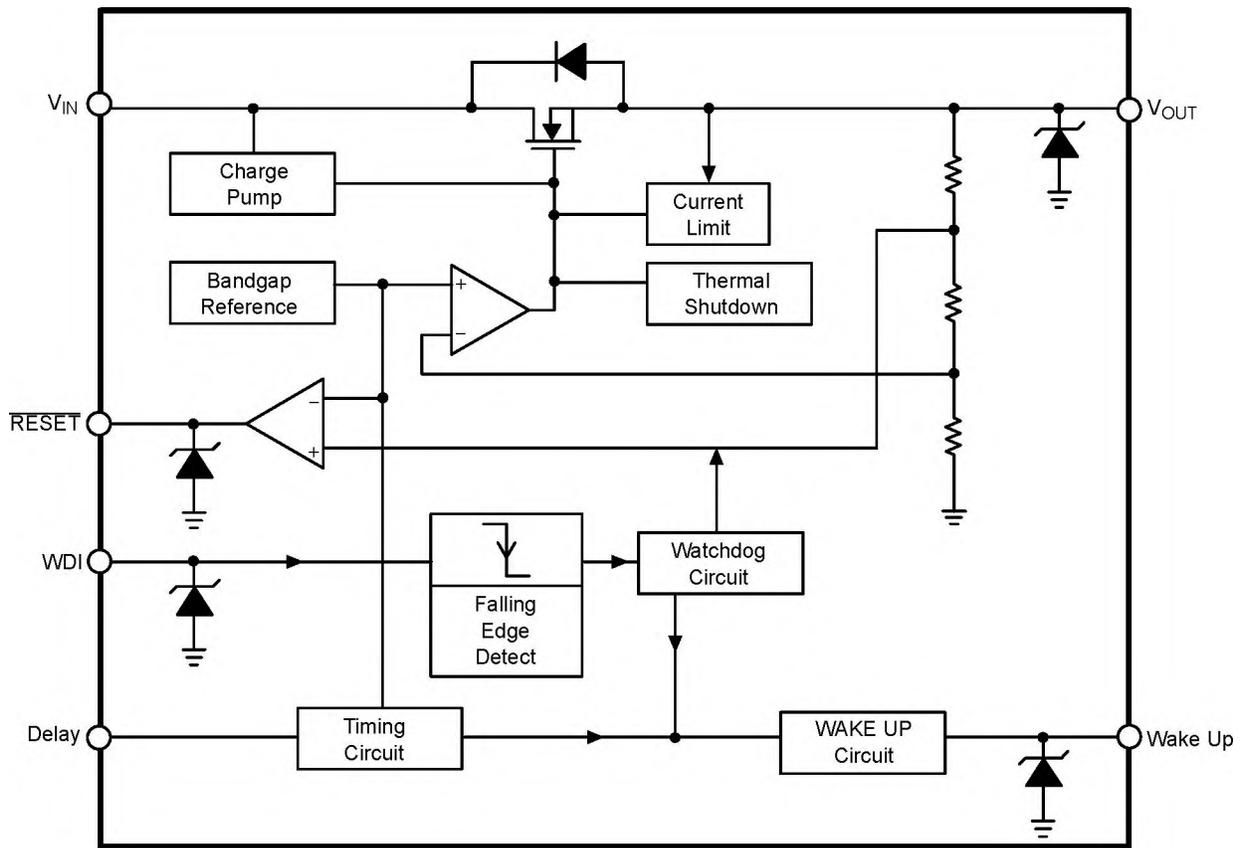


Figure 2. Block Diagram

TIMING DIAGRAMS

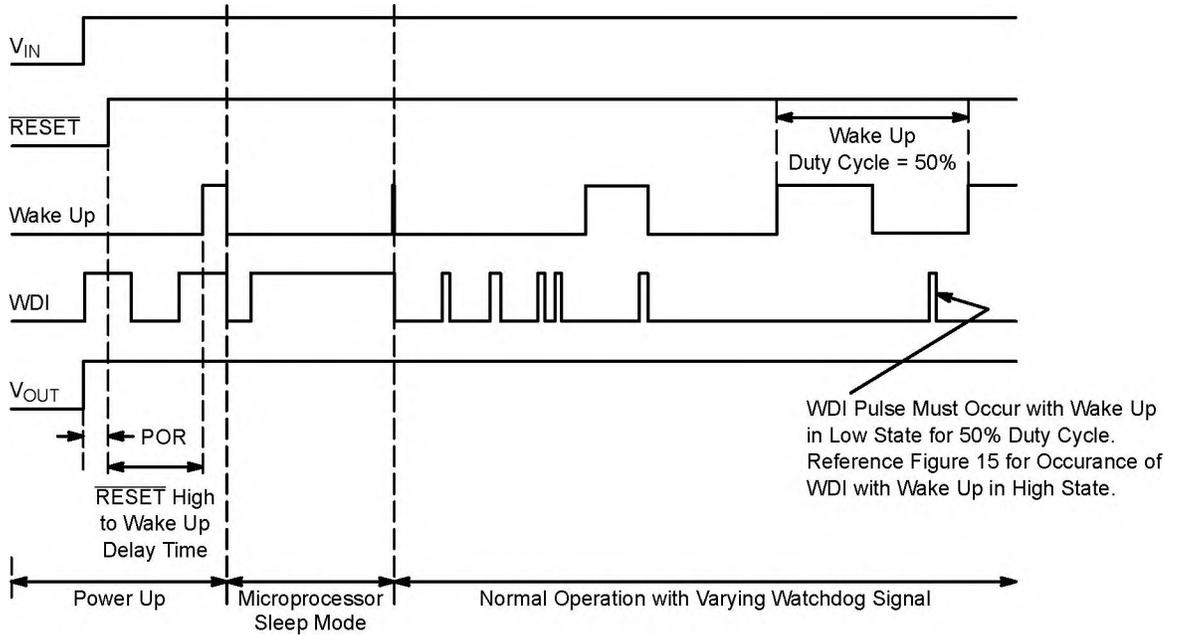


Figure 3. Power Up, Sleep Mode and Normal Operation

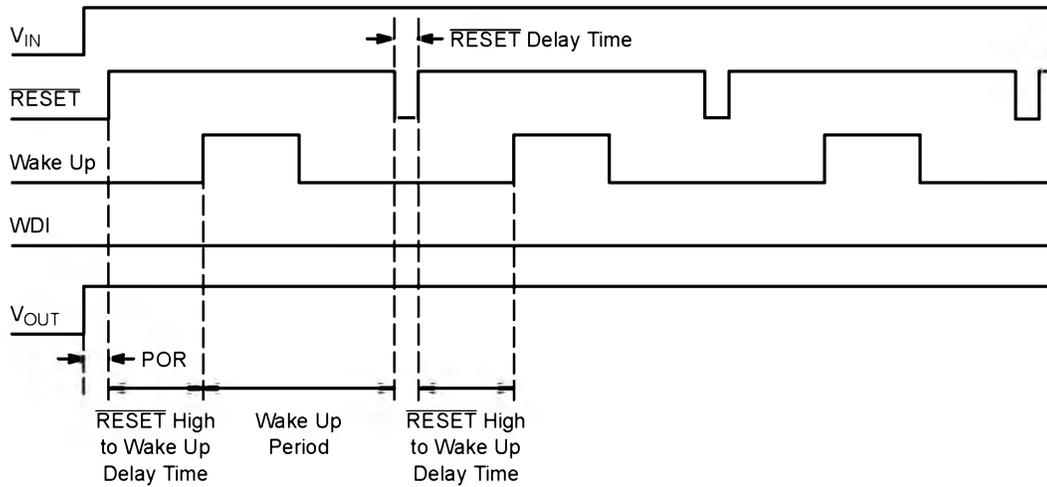


Figure 4. Error Condition: Watchdog Remains Low and a $\overline{\text{RESET}}$ Is Issued

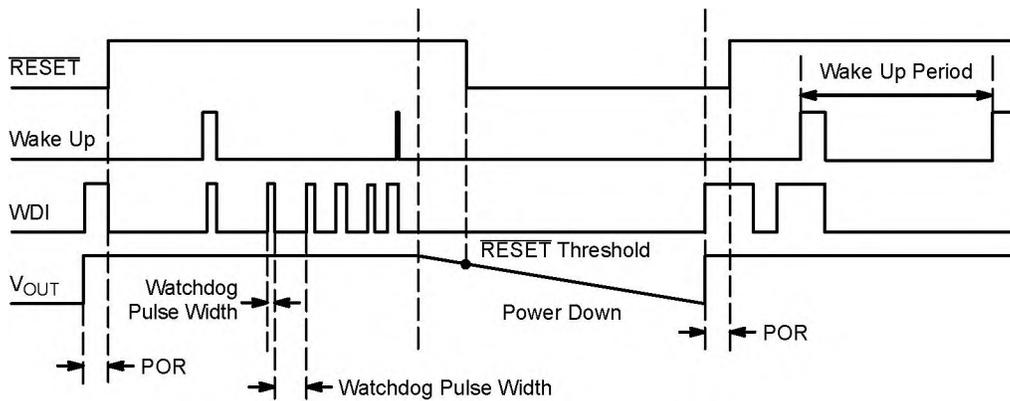


Figure 5. Power Down and Restart Sequence

TYPICAL PERFORMANCE CHARACTERISTICS

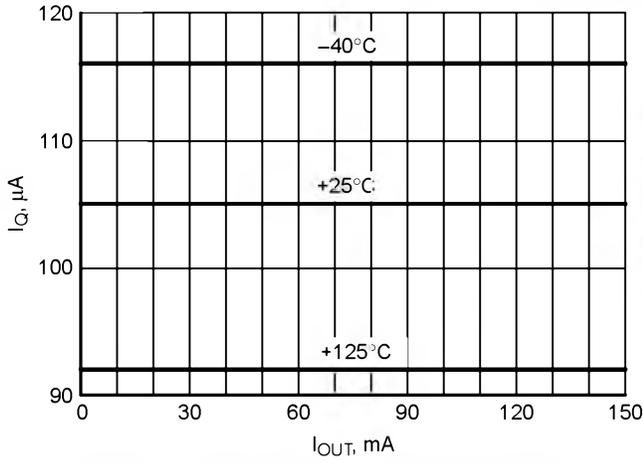


Figure 6. Quiescent Current vs Output Current

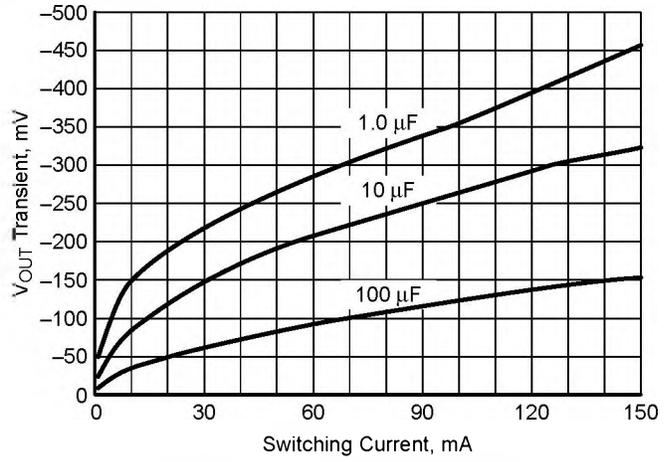


Figure 7. Load Transient Response

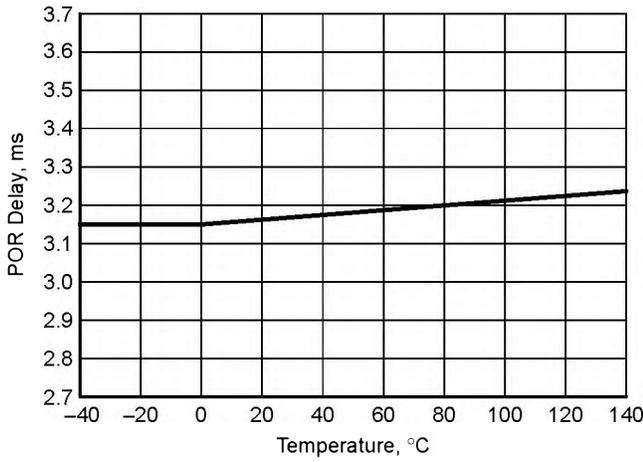


Figure 8. POR Delay vs Temp, $R_{DELAY} = 60\text{ k}\Omega$

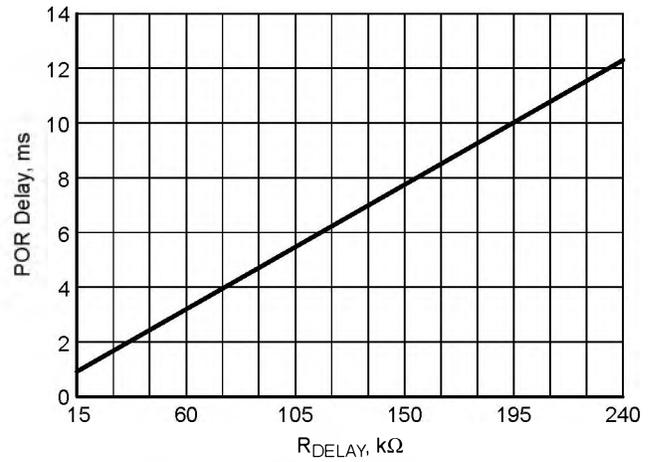


Figure 9. POR Delay vs R_{DELAY}

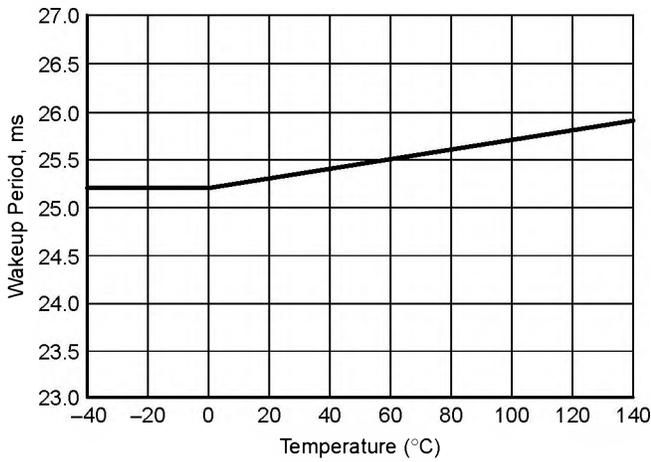


Figure 10. Wakeup Period vs Temp, $R_{DELAY} = 60\text{ k}\Omega$

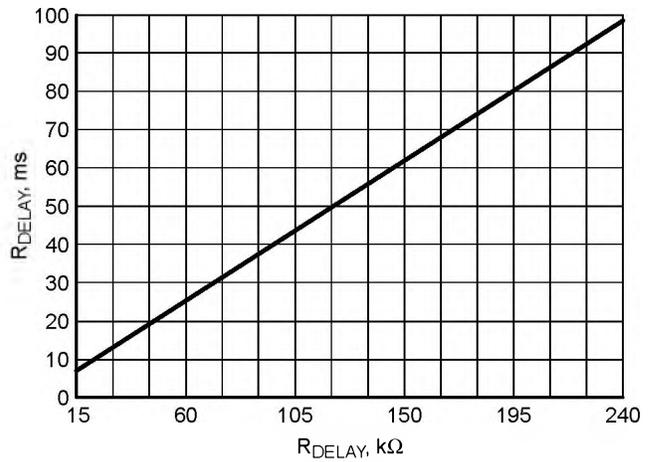


Figure 11. Wake Up Period vs R_{DELAY}

TYPICAL PERFORMANCE CHARACTERISTICS

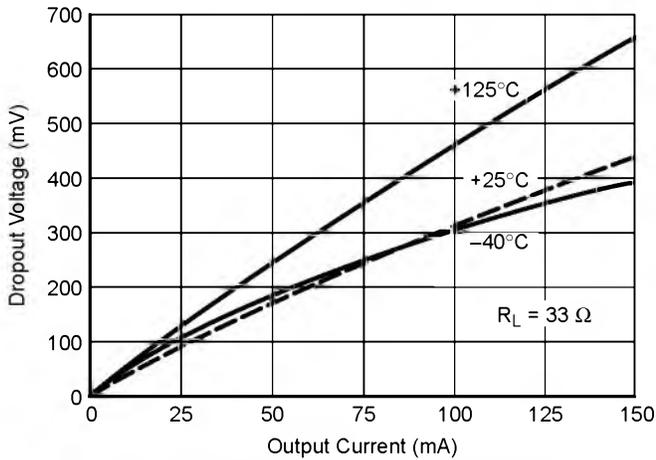


Figure 12. Dropout Voltage vs Output Current

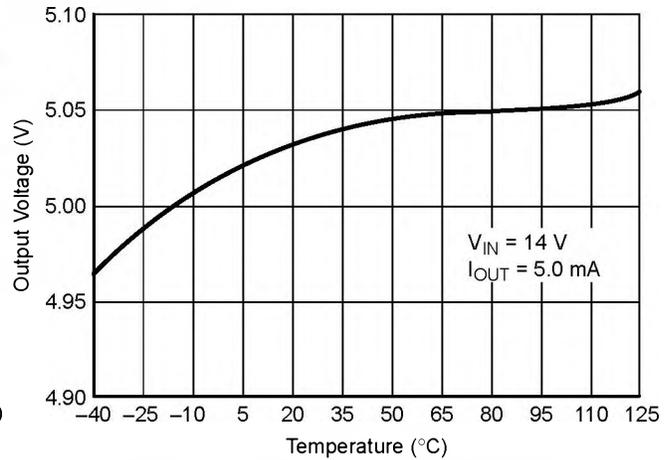


Figure 13. Output Voltage vs Temperature

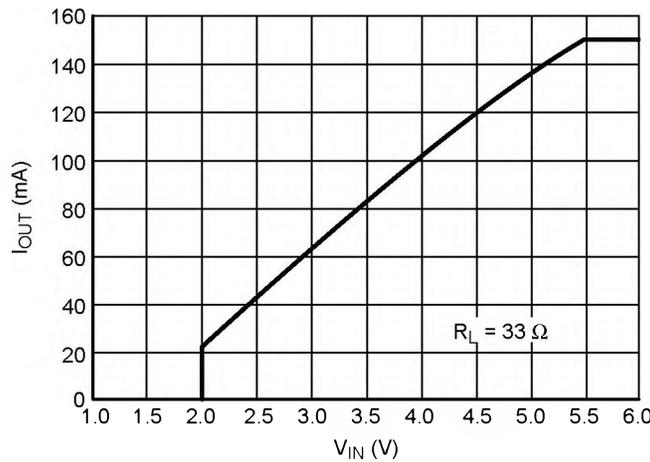


Figure 14. Output Current vs Input Voltage

DEFINITION OF TERMS

Dropout Voltage: The input–output voltage differential at which the circuit ceases to regulate against further reduction in input voltage. Measured when the output voltage has dropped 100 mV from the nominal value obtained at 14 V input, dropout voltage is dependent upon load current and junction temperature.

Input Voltage: The DC voltage applied to the input terminals with respect to ground.

Line Regulation: The change in output voltage for a change in the input voltage. The measurement is made under conditions of low dissipation or by using pulse techniques

such that the average chip temperature is not significantly affected.

Load Regulation: The change in output voltage for a change in load current at constant chip temperature.

Quiescent Current: The part of the positive input current that does not contribute to the positive load current. The regulator ground lead current.

Ripple Rejection: The ratio of the peak-to-peak input ripple voltage to the peak-to-peak output ripple voltage.

Current Limit: Peak current that can be delivered to the output.

DETAILED OPERATING DESCRIPTION

The NCV8508 is a precision micro–power voltage regulator with very low quiescent current (100 μ A typical at 250 mA load). A typical dropout voltage is 425 mV at 150 mA. Microprocessor control logic includes Watchdog,

Wake Up and $\overline{\text{RESET}}$. This unique combination of extremely low quiescent current and full microprocessor control makes the NCV8508 ideal for use in battery

operated, microprocessor controlled equipment in addition to being a good fit in the automotive environment.

The NCV8508 Wake Up function brings the microprocessor out of Sleep mode. The microprocessor in turn, signals its Wake Up status back to the NCV8508 by issuing a Watchdog signal.

The Watchdog logic function monitors an input signal (WDI) from the microprocessor. The NCV8508 responds to the falling edge of the Watchdog signal which it expects at least once during each wake-up period. When the correct Watchdog signal is received, a falling edge is issued on the wake-up signal line.

RESET is independent of V_{IN} and operates correctly to an output voltage as low as 1.0 V. A signal is issued in any of three situations. During power up the RESET is held low until the output voltage is in regulation. During operation if

the output voltage shifts below the regulation limits, the RESET toggles low and remains low until proper output voltage regulation is restored. And finally, a RESET signal is issued if the regulator does not receive a Watchdog signal within the Wake Up period.

The RESET pulse width, Wake Up signal frequency, and Wake Up delay time are all set by one external resistor, R_{Delay} .

The Delay pin is a buffered bandgap voltage (1.25 V). It can be used as a reference for an external tracking regulator like the CS8182.

The regulator is protected against short circuit and thermal runaway conditions. The device runs through 45 volt transients, making it suitable for use in automotive environments.

CIRCUIT DESCRIPTION

Functional Description

To reduce the drain on the battery a system can go into a low current consumption mode when ever its not performing a main routine. The Wake Up signal is generated continuously and is used to interrupt a microcontroller that is in sleep mode. The nominal output is a 5.0 volt square wave with a duty cycle of 50% at a frequency that is determined by a timing resistor, R_{Delay} .

When the microprocessor receives a rising edge from the Wake Up output, it must issue a watchdog pulse and check its inputs to decide if it should resume normal operations or remain in the sleep mode.

The first falling edge of the watchdog signal causes the Wake Up to go low within 2.0 μ s (typ) and remain low until the next Wake Up cycle (see Figure 15). Other watchdog pulses received within the same cycle are ignored (Figure 3).

During power up, RESET is held low until the output voltage is in regulation. During operation, if the output voltage shifts below the regulation limits, the RESET toggles low and remains low until proper output voltage regulation is restored. After the RESET delay, RESET returns high.

The Watchdog circuitry continuously monitors the input watchdog signal (WDI) from the microprocessor. The absence of a falling edge on the Watchdog input during one Wake Up cycle will cause a RESET pulse to occur at the end of the Wake Up cycle. (see Figure 4).

The Wake Up output is pulled low during a RESET regardless of the cause of the RESET. After the RESET returns high, the Wake Up cycle begins again (see Figure 4).

The RESET Delay Time, Wake Up signal frequency and RESET high to Wake Up delay time are all set by one external resistor R_{Delay} .

$$\begin{aligned} \text{Wake Up period} &= (4.17 \times 10^{-7})R_{Delay} \\ \text{RESET Delay Time} &= (5.21 \times 10^{-8})R_{Delay} \\ \text{RESET HIGH to Wake Up Delay Time} &= (2.08 \times 10^{-7})R_{Delay} \end{aligned}$$

Capacitor temperature coefficient and tolerance as well as the tolerance of the NCV8508 must be taken into account in order to get the correct system tolerance for each parameter.

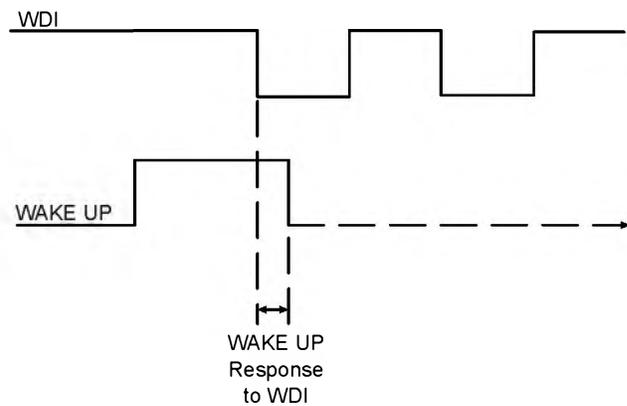


Figure 15. Wake Up Response to WDI

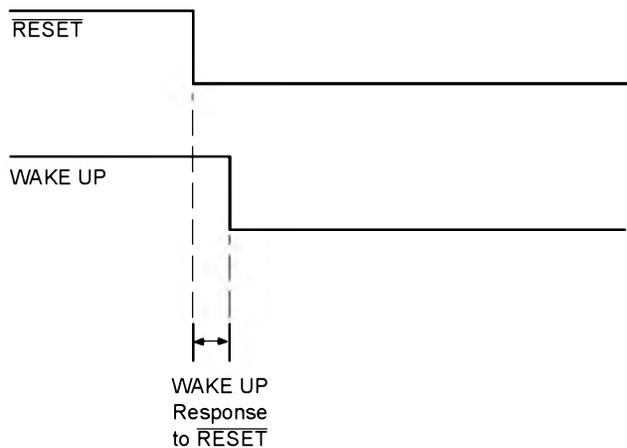


Figure 16. Wake Up Response to RESET (Low Voltage)

APPLICATION NOTES

Calculating Power Dissipation in a Single Output Linear Regulator

The maximum power dissipation for a single output regulator (Figure 17) is:

$$P_{D(max)} = [V_{IN(max)} - V_{OUT(min)}]I_{OUT(max)} + V_{IN(max)}I_Q \quad (1)$$

where:

$V_{IN(max)}$ is the maximum input voltage.

$V_{OUT(min)}$ is the minimum output voltage.

$I_{OUT(max)}$ is the maximum output current for the application, and

I_Q is the quiescent current the regulator consumes at $I_{OUT(max)}$.

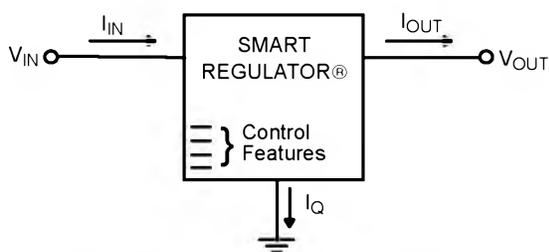


Figure 17. Single Output Regulator with Key Performance Parameters Labeled

Once the value of $P_{D(max)}$ is known, the maximum permissible value of $R_{\theta JA}$ can be calculated:

$$R_{\theta JA} = \frac{150^{\circ}\text{C} - T_A}{P_D} \quad (2)$$

The value of $R_{\theta JA}$ can then be compared with those in the package section of the data sheet. Those packages with $R_{\theta JA}$'s less than the calculated value in equation 2 will keep the die temperature below 150°C .

In some cases, none of the packages will be sufficient to dissipate the heat generated by the IC, and an external heatsink will be required.

Heat Sinks

A heat sink effectively increases the surface area of the package to improve the flow of heat away from the IC and into the surrounding air.

Each material in the heat flow path between the IC and the outside environment will have a thermal resistance. Like series electrical resistances, these resistances are summed to determine the value of $R_{\theta JA}$:

$$R_{\theta JA} = R_{\theta JC} + R_{\theta CS} + R_{\theta SA} \quad (3)$$

where:

$R_{\theta JC}$ = the junction-to-case thermal resistance.

$R_{\theta CS}$ = the case-to-heatsink thermal resistance, and

$R_{\theta SA}$ = the heatsink-to-ambient thermal resistance.

$R_{\theta JC}$ appears in the package section of the data sheet. Like $R_{\theta JA}$, it too is a function of package type. $R_{\theta CS}$ and $R_{\theta SA}$ are functions of the package type, heatsink and the interface between them. These values appear in heat sink data sheets of heat sink manufacturers.

ORDERING INFORMATION*

| Device | Output Voltage | Package | Shipping |
|----------------|----------------|--------------------|------------------|
| NCV8508D50 | 5.0 V | SO-8 | 95 Units/Rail |
| NCV8508D50R2 | | SO-8 | 2500 Tape & Reel |
| NCV8508DW50 | | SO-16L | 46 Units/Rail |
| NCV8508DW50R2 | | SO-16L | 1000 Tape & Reel |
| NCV8508PDW50 | | SOW-16 Exposed Pad | 46 Units/Rail |
| NCV8508PDW50R2 | | SOW-16 Exposed Pad | 1000 Tape & Reel |

*Consult your local sales representative for 3.3 V option.